AUTOMOTIVE

RoHS

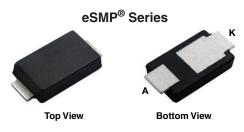
COMPLIANT

HALOGEN FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



SMPA (DO-221BC)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	8.0 A		
V_{RRM}	120 V		
I _{FSM}	100 A		
V_F at $I_F = 8.0 \text{ A} (T_A = 125 ^{\circ}\text{C})$	0.65 V		
T _J max.	175 °C		
Package	SMPA (DO-221BC)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

MECHANICAL DATA

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8PAM12	UNIT	
Device marking code		8M12		
Maximum repetitive peak reverse voltage	V _{RRM}	120	V	
Maximum DC forward current	I _{F(AV)} (1)	8.0	Α	
Maximum DC forward current	I _{F(AV)} (2)	2.7		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100	А	
Operating junction and storage temperature range	T _J , T _{STG}	-40 to +175	°C	

Notes

- (1) Units mounted on 3 cm x 3 cm aluminum PCB
- (2) Free air, mounted on recommended copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4.0 A	T _A = 25 °C	V _E (1)	0.63	-	V
	$I_F = 8.0 A$			0.8	0.88	
	$I_F = 4.0 A$	T _A = 125 °C	'	0.54	-	
	I _F = 8.0 A			0.65	0.73	
Reverse current	V _B = 90 V	T _A = 25 °C T _A = 125 °C	I _R ⁽²⁾	0.01	-	mA
	V _R = 90 V	T _A = 125 °C		1.5	-	
	V _R = 120 V	T _A = 25 °C	IR (=)	-	0.5	I IIIA
	v _R = 120 v	T _A = 125 °C		3	10	
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		730	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	RAMETER SYMBOL V8PAM12			
Typical thermal resistance	R _{θJA} (1)(2)	100	°C/W	
Typical thermal resistance	R _{θJM} ⁽³⁾	5]	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta,JA}$
- (2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{θJA} junction to ambient
- $^{(3)}$ Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PAM12-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
V8PAM12HM3/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

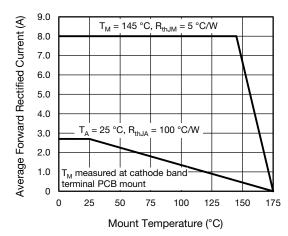


Fig. 1 - Maximum Forward Current Derating Curve

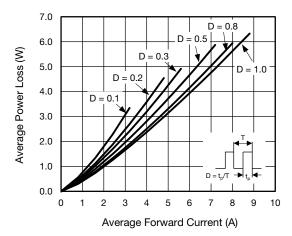


Fig. 2 - Forward Power Loss Characteristics



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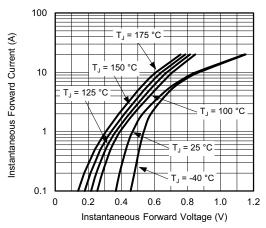


Fig. 3 - Typical Instantaneous Forward Characteristics

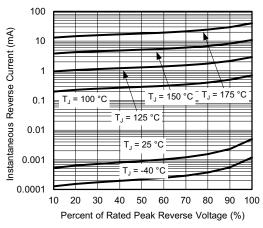


Fig. 4 - Typical Reverse Leakage Characteristics

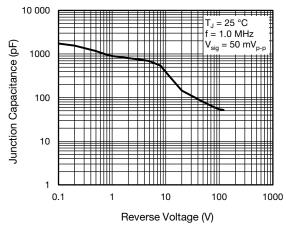


Fig. 5 - Typical Junction Capacitance

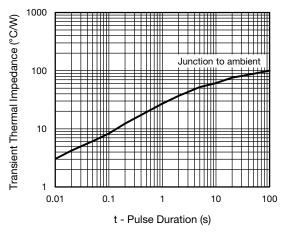


Fig. 6 - Typical Transient Thermal Impedance

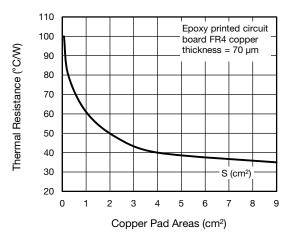


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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0.217 (5.52)

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPA (DO-221BC) 0.059 (1.50) 0.122 (3.10) 0.030 (0.75) Cathode Band 0.098 (2.50) 0.106 (2.70) 0.057 (1.45) 0.087 (2.20) 0.098 (2.50) 0.049 (1.25) 0.063 (1.6) 0.171 (4.35) Typ.: 0.019 (0.48) 0.059 (1.50) 0.163 (4.15) 0.030 (0.75) 0.211 (5.35) 0.199 (5.05) **Mounting Pad Layout** MAX. 0.037 (0.92) 0.039 (1.00) 0.012 (0.30) 0.035 (0.90) 0.006 (0.15) 0.087 (2.20) 0.060 (1.52) MIN. MIN. MIN. 0.059 (1.50) MIN. 0.122 (3.10)



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